VEMD4060X02

Vishay Semiconductors



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LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

The VEMD4060X02 is a high speed and high sensitive PIN photodiode with a highly linear photoresponse. It is a low profile surface-mount device (SMD) with a 0.375 mm² sensitive area detecting visible and near infrared radiation.

FEATURES

- Package type: surface-mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.7
- Radiant sensitive area (in mm²): 0.375
- Ambient temperature range: T_{OP} = -40 °C to +125 °C
- Angle of half sensitivity: $\phi = \pm 58^{\circ}$
- · Floor life: 4 weeks, MSL2a, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- AEC-Q102 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · High speed photo detector
- Photo interrupters
- Automotive sensors
- Hygienic applications

PRODUCT SUMMARY				
COMPONENT	I _{ra} (μΑ) φ (°)		λ _{0.5} (nm)	
VEMD4060X02	1.5	± 58	540 to 960	

Note

• Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VEMD4060X02	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805	

Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25 \degree C$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	20	V
Ambient temperature range		T _{amb}	-40 to +125	°C
Storage temperature range		T _{stg}	-40 to +125	°C
Soldering temperature	According to reflow solder profile Fig. 8	T _{sd}	260	°C

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COMPLIANT



VEMD4060X02



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BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 50 mA	V _F	-	1.0	1.3	V
Breakdown voltage	$I_R = 100 \ \mu A, E = 0 \ mW/cm^2$	V _(BR)	20	-	-	V
Reverse dark current	V _R = 10 V, E = 0	I _{ro}	-	-	3	nA
Diode capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$	CD	-	7.6	-	pF
Short circuit current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 940 \text{ nm}$	l _k	-	1.5	-	μA
Open circuit voltage	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 940 \text{ nm}$	Vo	-	355	-	mV
Temperature coefficient of I_k	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 940 \text{ nm}$	TK _{lk}	-	0.37	-	%/K
Reverse light current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 850 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	1.7	2.3	2.9	μA
	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 940 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	1.0	1.5	1.9	μA
Angle of half sensitivity		φ	-	± 58	-	0
Wavelength of peak sensitivity		λρ	-	820	-	nm
Range of spectral bandwidth	S _{rel} > 0.5	λ _{0.5}	-	540 to 960	-	nm
Rise time	V_R = 10 V, R_L = 50 Ω , λ = 890 nm	t _r	-	160	-	ns
Fall time	V_R = 10 V, R_L = 50 Ω , λ = 890 nm	t _f	-	125	-	ns

BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

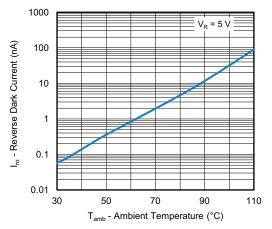


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

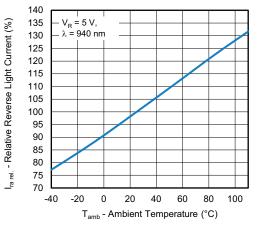


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

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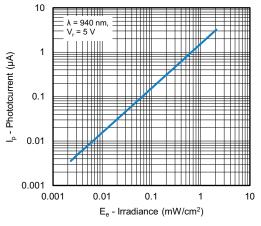


Fig. 3 - Reverse Light Current vs. Irradiance

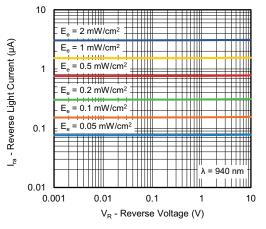


Fig. 4 - Reverse Light Current vs. Reverse Voltage

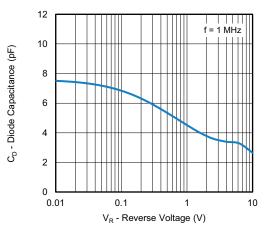


Fig. 5 - Diode Capacitance vs. Reverse Voltage

 $s(\lambda)_{\Phi, \ rel.}$ - Relative Spectral Sensitivity (%) λ - Wavelength (nm)

Fig. 6 - Relative Spectral Sensitivity vs. Wavelength

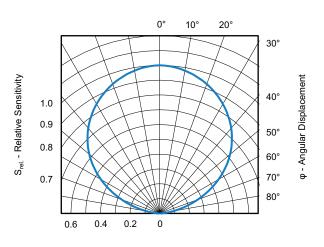
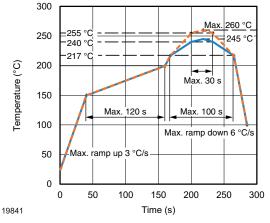


Fig. 7 - Relative Sensitivity vs. Angular Displacement

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REFLOW SOLDER PROFILE

ISHA)



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Fig. 8 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

PACKAGE DIMENSIONS in millimeters

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

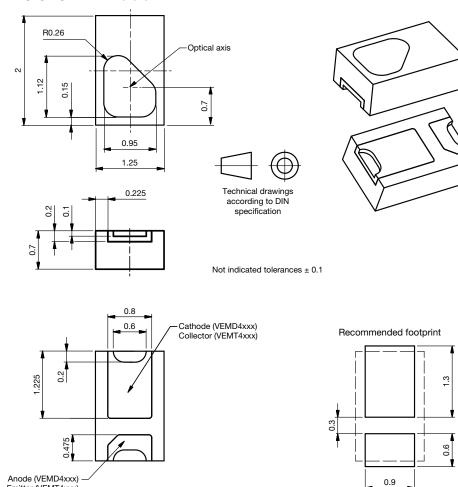
Floor life: 4 weeks

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 2a, according to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.



Anode (VEMD4xxx) Emitter (VEMT4xxx)

Drawing-No.: 6.550-5363.01-4 Issue: 2; 01.07.2020

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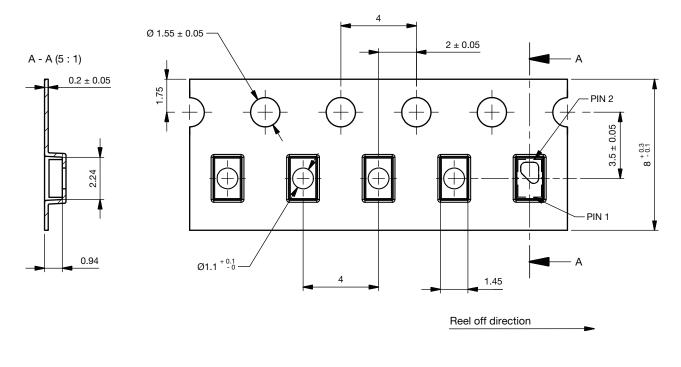
Document Number: 80402

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BLISTER TAPE DIMENSIONS in millimeters



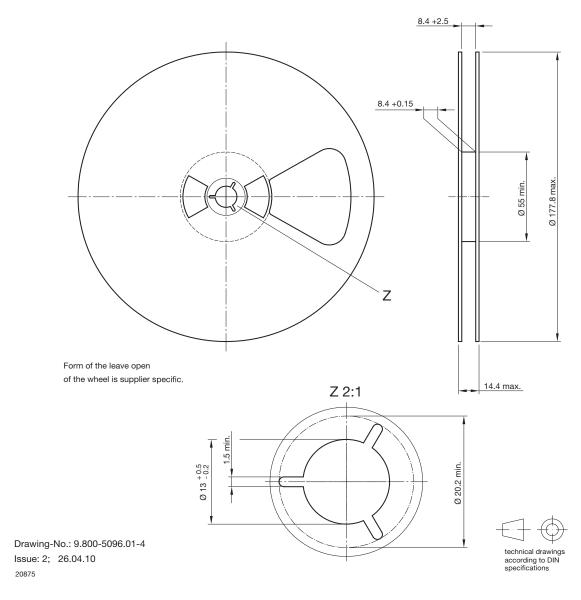
TYPE	PIN 1	PIN 2
VEMD4xxx	Anode	Cathode

Drawing-No.: 9.700-5411.0-4 Issue: 1_A; 11.10.2022





REEL DIMENSIONS in millimeters





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